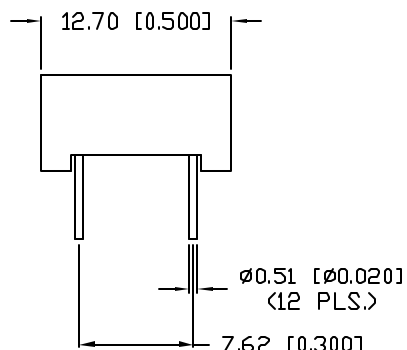
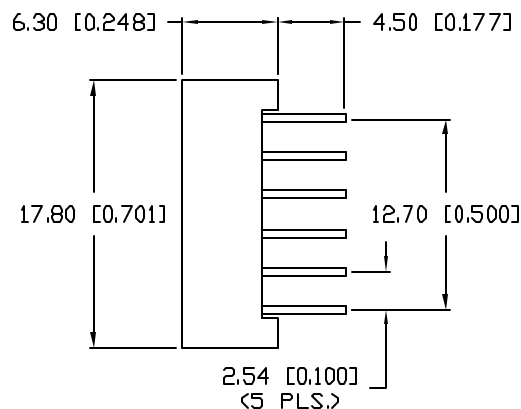
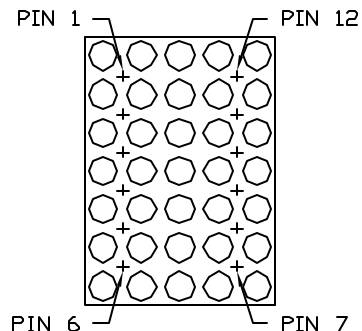


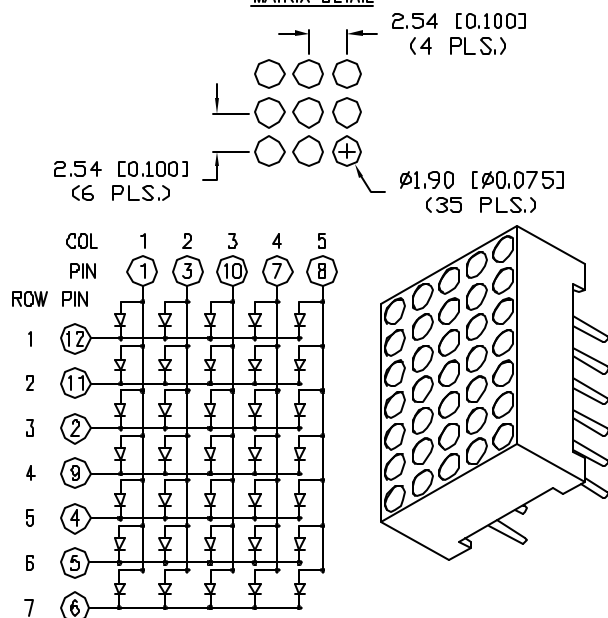
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PART NUMBER  
LDM-07657MI

REV.  
C



MATRIX DETAIL



REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10BRDR.	7.12.99
B	E.C.N. #10BRDR. & REDRAWN IN 3D.	6.28.03
C	E.C.N. #11148.	03.21.07

ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^\circ\text{C}$   $I_f=10\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660		nm	
FORWARD VOLTAGE		1.7	2.2	$V_f$	
REVERSE VOLTAGE	4.0			$V_r$	$I_r=100\mu\text{A}$
AXIAL INTENSITY		6000		$\mu\text{cd}$	$I_f=10\text{mA}$
EMITTED COLOR:	RED				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT  $25^\circ\text{C}$  PER DOT

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	100	mW
DERATE FROM $25^\circ\text{C}$	-1.6	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY		3 SEC. MAX

\*  $t < 10\mu\text{s}$



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\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= <sup>+0.00</sup> <sub>-0.00</sub> DECIMAL PRECISION MAX.= <sup>+0.00</sup> <sub>-0.00</sub> DECIMAL PRECISION

REV. C	PART NUMBER LDM-07657MI
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0.70" 5 x 7 DOT MATRIX, LED DISPLAY,  
660nm RED DOTS, GRAY FACE WITH WHITE SEGMENTS,  
COLUMN ANODE, 12 PINS.

**RELIABILITY NOTE**  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: JC	CHECKED BY:	APPROVED BY:	DATE: 11.4.93
			PAGE: 1 OF 1
			SCALE: N/A